

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	5085	terada-y\$.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 21:56
L2	42	terada-y\$.in. and polyimide	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 21:56
L3	714	namikawa-m\$.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:01
L4	20	namikawa-m\$.in. and polyimide	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:01
L5	103	uenda-d\$.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:01
L6	15	uenda-d\$.in. and polyimide	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:02
L7	148	funatsu-a\$.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:02
L8	4	funatsu-a\$.in. and polyimide	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:02
L9	12	(releasable or protective) same ((cleaning adj1 layer) or polyimide) same (support or backing) same adhesive adj1 layer same (carrying or semiconductor or wafer or panel or display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:03

L10	28	(releasable or protective) same ((cleaning adj1 layer) or polyimide) same (support or backing) same adhesive adj1 layer and (carrying or semiconductor or wafer or panel or display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:04
L11	12706	(releasable or protective) and ((cleaning adj1 layer) or polyimide) and (support or backing) and adhesive and (carrying or semiconductor or wafer or panel or display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:10
L12	8511	(releasable or protective) and ((cleaning adj1 layer) or polyimide) and (support or backing) and adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:10
L13	387	(releasable or protective) same ((cleaning adj1 layer) or polyimide) same (support or backing) and adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:11
L14	0	(releasable or protective) same ((cleaning adj1 layer) near8 polyimide) same (support or backing) same adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:11

L15	2	(releasable or protective) and (cleaning adj1 layer) near8 polyimide and (support or backing) and adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:11
L16	4	(releasable or protective) and (cleaning adj1 layer) same polyimide and (support or backing) and adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:12
L17	13	(cleaning adj1 layer) same polyimide and (support or backing) and adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:22
L18	9	(cleaning adj1 layer) same polyimide same adhesive and (semiconductor or wafer or panel near3 display)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2010/01/28 22:40

EAST Search History (Interference)

<This search history is empty>

1/28/10 10:40:57 PM**C:\My Documents\EAST\Workspaces\10823654.1.wsp**